

Vishay Siliconix

P-Channel 1.8-V (G-S) MOSFET

| PRODUCT SUMMARY | | | | | | |
|---------------------|------------------------------------|---------------------------------|-----------------------|--|--|--|
| V _{DS} (V) | R _{DS(on)} (Ω) | I _D (A) ^b | Q _g (Typ.) | | | |
| | 0.009 at V _{GS} = - 4.5 V | - 13.7 | | | | |
| - 8 | 0.011 at V _{GS} = - 2.5 V | - 12.4 | 55 nC | | | |
| | 0.016 at V _{GS} = - 1.8 V | - 10 | | | | |

FEATURES

Halogen-free According to IEC 61249-2-21
Available

GO

- TrenchFET[®] Power MOSFET
- 1.8 V Rated
- 100 % Rg Tested



Available

Si4465ADY-T1-GE3 (Lead (Pb)-free and Halogen-free)

Ordering Information: Si4465ADY-T1-E3 (Lead (Pb)-free)





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| ABSOLUTE MAXIMUM RATINGS | T _A = 25 °C, unles | ss otherwise n | oted | |
|--|--|-----------------|----------------|------|
| Parameter | | Symbol | Limit | Unit |
| Drain-Source Voltage | V _{DS} | - 8 | V | |
| Gate-Source Voltage | V _{GS} | ± 8 | v | |
| | T _A = 25 °C T _A = 70 °C | | - 13.7 - 11 | |
| Continuous Drain Current $(T_J = 150 \ ^{\circ}C)^{a, b}$ | $T_{C} = 25 \text{ °C}$ $T_{C} = 70 \text{ °C}$ | I _D | - 20 - 16 | А |
| Pulsed Drain Current | | I _{DM} | - 40 | |
| Continuous Source Current (Diode Conduction) ^{a, b} | | ۱ _S | - 2.5 | |
| | | I _{SM} | 40 | 1 |
| | T _A = 25 °C T _A = 70 °C | | 3.0 1.95 | |
| Maximum Power Dissipation ^{a, b} | $T_{C} = 25 \text{ °C}$ $T_{C} = 70 \text{ °C}$ | P _D | 6.5 4.2 | W |
| Operating Junction and Storage Temperature Rang | T _J , T _{stq} | - 55 to 150 | °C | |

| THERMAL RESISTANCE RATINGS | | | | | | |
|---|--------------|-------------------|---------|---------|------|--|
| Parameter | | Symbol | Typical | Maximum | Unit | |
| Maximum lunction to Ambient (MOCEET) | t ≤ 10 s | R _{thJA} | 34 | 41 | °C/W | |
| Maximum Junction-to-Ambient (MOSFET) ^a | Steady State | | 67 | 80 | 0/10 | |
| Maximum Junction-to-Foot (Drain) | Steady State | R _{thJF} | 15 | 19 | | |

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

b. $t \leq$ 10 s.

SO-8 D S 8 1 D S 7 2 D S 6 3 D G 5 4 Top View

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| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | |
|---|---------------------|--|--------|--------------|-------|------|--|
| Static | | | | | | | |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$ | - 0.45 | | - 1.0 | V | |
| Gate-Body Leakage | I _{GSS} | $V_{DS} = 0 V, V_{GS} = \pm 8 V$ | | | ± 100 | nA | |
| | I _{DSS} | $V_{DS} = -8 V, V_{GS} = 0 V$ $V_{DS} = -8 V, V_{GS} = 0 V, T_{J} = 55 °C$ | | | - 1 | μA | |
| Zero Gate Voltage Drain Current | | | | | - 5 | | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \ge -5$ V, V_{GS} = -4.5 V | - 20 | | | Α | |
| | | V _{GS} = - 4.5 V, I _D = - 14 A | | 0.0075 0.009 | | | |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | V _{GS} = - 2.5 V, I _D = - 12 A | | 0.0092 | 0.011 | Ω | |
| | | $V_{GS} = 1.8 \text{ V}, \text{ I}_{D} = 10 \text{ A}$ | | 0.013 | 0.016 | | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = - 10 V, I _D = - 14 A | | 58 | | S | |
| Diode Forward Voltage ^a | V _{SD} | $I_{S} = -2.1 \text{ A}, V_{GS} = 0 \text{ V}$ | | - 0.57 | - 1.2 | V | |
| Dynamic ^b | | | 1 | J J | | | |
| Total Gate Charge | Qg | | | 55 | 85 | | |
| Gate-Source Charge | Q _{gs} | V_{DS} = - 4 V, V_{GS} = - 4.5 V, I_{D} = - 14 A | | 6 | | nC | |
| Gate-Drain Charge | Q _{gd} | | | | | | |
| Gate Resistance | Rg | | | 2.5 | 3.8 | Ω | |
| Turn-On Delay Time | t _{d(on)} | | | 33 | 50 | | |
| Rise Time | t _r | V_{DD} = - 4 V, R_L = 4 Ω | | 170 | 255 | | |
| Turn-Off Delay Time | t _{d(off)} | $\text{I}_{\text{D}}\cong$ - 10 A, V_{GEN} = - 4.5 V, R_{g} = 6 Ω | | 168 | 255 | ns | |
| Fall Time | t _f | | | 112 | 170 | 1 | |
| Source-Drain Reverse Recovery Time | t _{rr} | I _F = - 2.1 A, dl/dt = 100 A/μs | | 85 | 130 | 1 | |
| Body Diode Reverse Recovery Charge | Q _{rr} | $F = -2.1 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$ | | 81 | 125 | nC | |

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

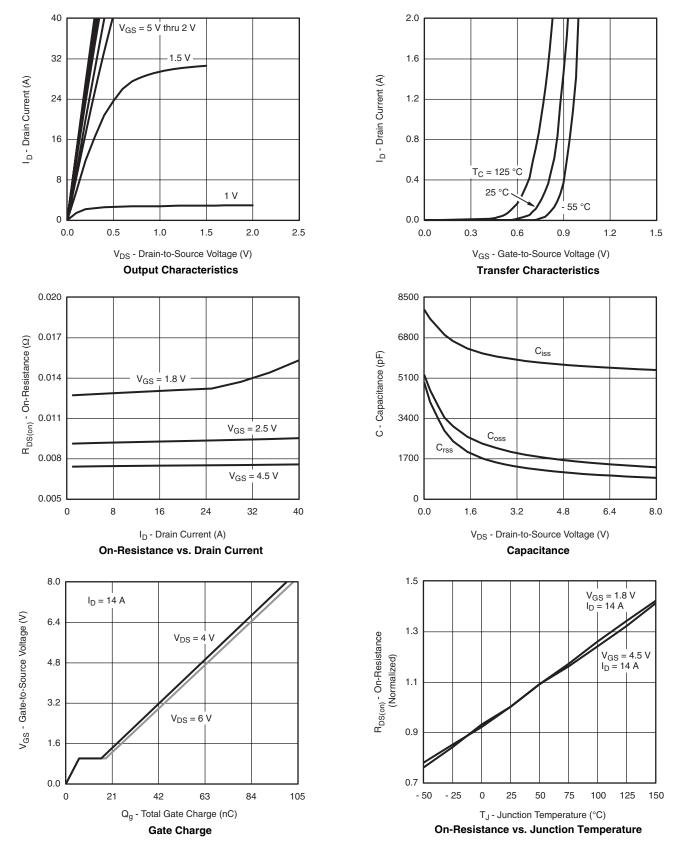
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



Si4465ADY

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

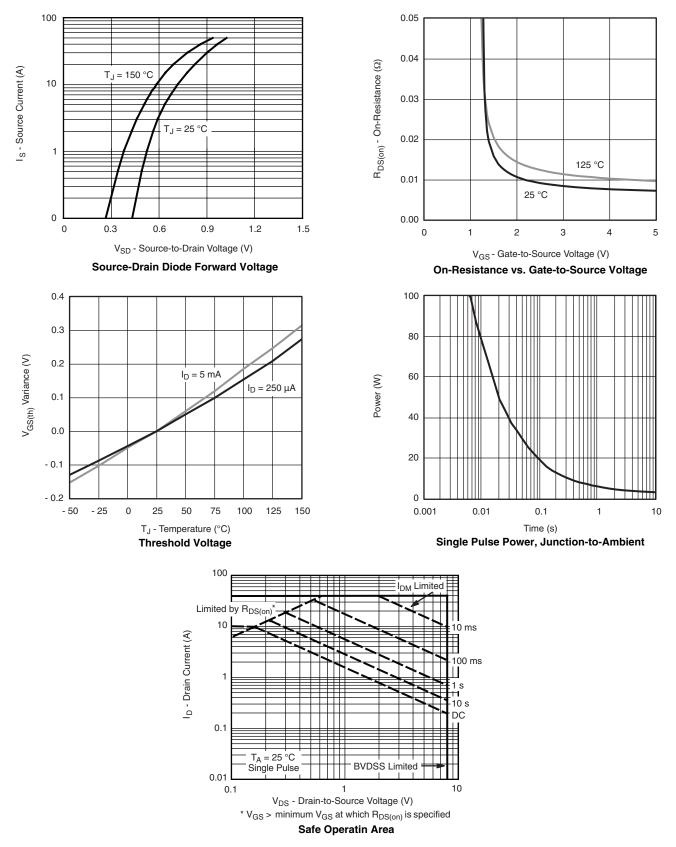


Si4465ADY

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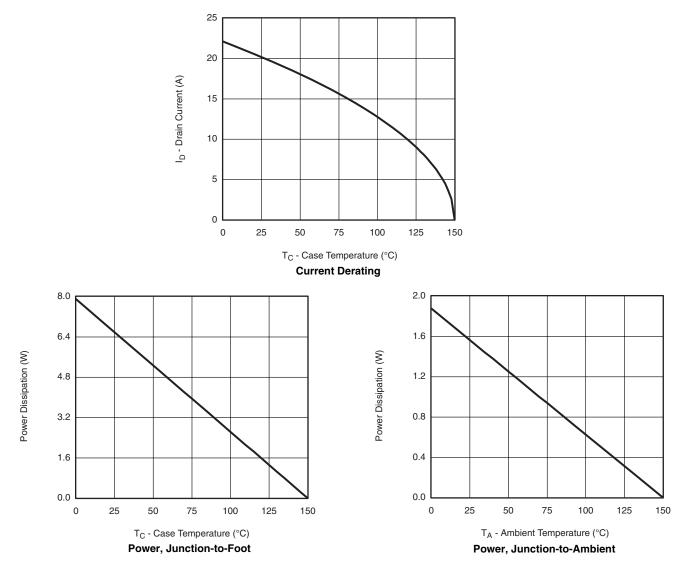
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





Si4465ADY Vishay Siliconix

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



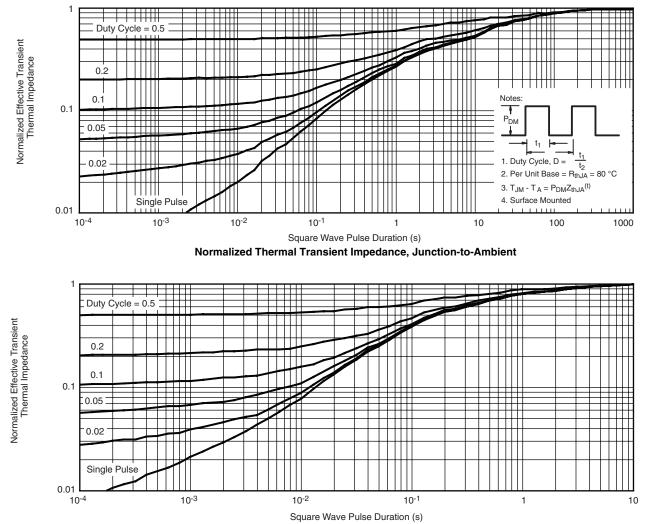
* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?73856.



Package Information

Vishay Siliconix

SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012





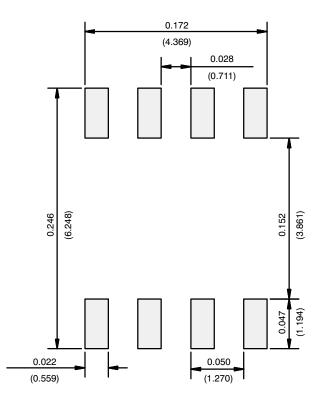
| | MILLIM | IETERS | INCHES | | | |
|---|----------|--------|-----------|-------|--|--|
| DIM | Min | Мах | Min | Max | | |
| A | 1.35 | 1.75 | 0.053 | 0.069 | | |
| A ₁ | 0.10 | 0.20 | 0.004 | 0.008 | | |
| В | 0.35 | 0.51 | 0.014 | 0.020 | | |
| С | 0.19 | 0.25 | 0.0075 | 0.010 | | |
| D | 4.80 | 5.00 | 0.189 | 0.196 | | |
| E | 3.80 | 4.00 | 0.150 | 0.157 | | |
| е | 1.27 BSC | | 0.050 BSC | | | |
| н | 5.80 | 6.20 | 0.228 | 0.244 | | |
| h | 0.25 | 0.50 | 0.010 | 0.020 | | |
| L | 0.50 | 0.93 | 0.020 | 0.037 | | |
| q | 0° | 8° | 0° | 8° | | |
| S | 0.44 | 0.64 | 0.018 | 0.026 | | |
| ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498 | | | | | | |

Application Note 826

Vishay Siliconix



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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